

## OptiMOS<sup>®</sup> -T2 Power-Transistor



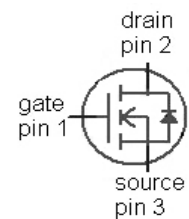
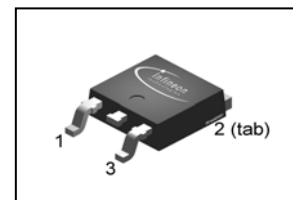
### Features

- N-channel - Enhancement mode
- Automotive AEC Q101 qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green product (RoHS compliant)
- Ultra low R<sub>DS(on)</sub>
- 100% Avalanche tested

### Product Summary

|                  |      |    |
|------------------|------|----|
| $V_{DS}$         | 30   | V  |
| $R_{DS(on),max}$ | 13.6 | mΩ |
| $I_D$            | 30   | A  |

### PG-TO252-3-11



| Type           | Package       | Marking |
|----------------|---------------|---------|
| IPD30N03S4L-14 | PG-TO252-3-11 | 4N03L14 |

**Maximum ratings**, at  $T_J=25\text{ °C}$ , unless otherwise specified

| Parameter                              | Symbol            | Conditions                                         | Value        | Unit |
|----------------------------------------|-------------------|----------------------------------------------------|--------------|------|
| Continuous drain current <sup>1)</sup> | $I_D$             | $T_C=25\text{ °C}$ , $V_{GS}=10\text{ V}$          | 30           | A    |
|                                        |                   | $T_C=100\text{ °C}$ ,<br>$V_{GS}=10\text{ V}^{2)}$ | 27           |      |
| Pulsed drain current <sup>2)</sup>     | $I_{D,pulse}$     | $T_C=25\text{ °C}$                                 | 120          |      |
| Avalanche energy, single pulse         | $E_{AS}$          | $I_D=30\text{ A}$                                  | 16           | mJ   |
| Avalanche current, single pulse        | $I_{AS}$          | $T_C=25\text{ °C}$                                 | 30           | A    |
| Gate source voltage                    | $V_{GS}$          |                                                    | ±16          | V    |
| Power dissipation                      | $P_{tot}$         | $T_C=25\text{ °C}$                                 | 31           | W    |
| Operating and storage temperature      | $T_J$ , $T_{stg}$ |                                                    | -55 ... +175 | °C   |
| IEC climatic category; DIN IEC 68-1    |                   |                                                    | 55/175/56    |      |

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

### Thermal characteristics<sup>2)</sup>

|                                     |            |                                              |   |   |     |     |
|-------------------------------------|------------|----------------------------------------------|---|---|-----|-----|
| Thermal resistance, junction - case | $R_{thJC}$ |                                              | - | - | 4.9 | K/W |
| SMD version, device on PCB          | $R_{thJA}$ | minimal footprint                            | - | - | 62  |     |
|                                     |            | 6 cm <sup>2</sup> cooling area <sup>3)</sup> | - | - | 40  |     |

### Electrical characteristics, at $T_j=25\text{ °C}$ , unless otherwise specified

#### Static characteristics

|                                  |               |                                                                 |     |      |      |               |
|----------------------------------|---------------|-----------------------------------------------------------------|-----|------|------|---------------|
| Drain-source breakdown voltage   | $V_{(BR)DSS}$ | $V_{GS}=0\text{ V}, I_D=1\text{ mA}$                            | 30  | -    | -    | V             |
| Gate threshold voltage           | $V_{GS(th)}$  | $V_{DS}=V_{GS}, I_D=10\text{ }\mu\text{A}$                      | 1.0 | 1.5  | 2.2  |               |
| Zero gate voltage drain current  | $I_{DSS}$     | $V_{DS}=30\text{ V}, V_{GS}=0\text{ V}, T_j=25\text{ °C}$       | -   | 0.01 | 1    | $\mu\text{A}$ |
|                                  |               | $V_{DS}=30\text{ V}, V_{GS}=0\text{ V}, T_j=125\text{ °C}^{2)}$ | -   | 10   | 1000 |               |
|                                  |               | $V_{DS}=18\text{ V}, V_{GS}=0\text{ V}, T_j=85\text{ °C}^{2)}$  | -   | 5    | 60   |               |
| Gate-source leakage current      | $I_{GSS}$     | $V_{GS}=16\text{ V}, V_{DS}=0\text{ V}$                         | -   | 1    | 100  | nA            |
| Drain-source on-state resistance | $R_{DS(on)}$  | $V_{GS}=4.5\text{ V}, I_D=15\text{ A}$                          | -   | 16.1 | 20.5 | m $\Omega$    |
|                                  |               | $V_{GS}=10\text{ V}, I_D=30\text{ A}$                           | -   | 11.2 | 13.6 |               |

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

### Dynamic characteristics<sup>2)</sup>

|                              |              |                                                                                 |   |     |     |    |
|------------------------------|--------------|---------------------------------------------------------------------------------|---|-----|-----|----|
| Input capacitance            | $C_{iss}$    | $V_{GS}=0\text{ V}, V_{DS}=25\text{ V},$<br>$f=1\text{ MHz}$                    | - | 750 | 980 | pF |
| Output capacitance           | $C_{oss}$    |                                                                                 | - | 190 | 250 |    |
| Reverse transfer capacitance | $C_{rss}$    |                                                                                 | - | 10  | 20  |    |
| Turn-on delay time           | $t_{d(on)}$  | $V_{DD}=15\text{ V}, V_{GS}=10\text{ V},$<br>$I_D=30\text{ A}, R_G=3.5\ \Omega$ | - | 3   | -   | ns |
| Rise time                    | $t_r$        |                                                                                 | - | 2   | -   |    |
| Turn-off delay time          | $t_{d(off)}$ |                                                                                 | - | 12  | -   |    |
| Fall time                    | $t_f$        |                                                                                 | - | 2   | -   |    |

### Gate Charge Characteristics<sup>2)</sup>

|                       |               |                                                                            |   |     |    |    |
|-----------------------|---------------|----------------------------------------------------------------------------|---|-----|----|----|
| Gate to source charge | $Q_{gs}$      | $V_{DD}=24\text{ V}, I_D=30\text{ A},$<br>$V_{GS}=0\text{ to }10\text{ V}$ | - | 2.2 | 3  | nC |
| Gate to drain charge  | $Q_{gd}$      |                                                                            | - | 1.4 | 3  |    |
| Gate charge total     | $Q_g$         |                                                                            | - | 11  | 14 |    |
| Gate plateau voltage  | $V_{plateau}$ |                                                                            | - | 3.4 | -  | V  |

### Reverse Diode

|                                                |               |                                                                   |     |      |     |    |
|------------------------------------------------|---------------|-------------------------------------------------------------------|-----|------|-----|----|
| Diode continuous forward current <sup>2)</sup> | $I_S$         | $T_C=25\text{ °C}$                                                | -   | -    | 30  | A  |
| Diode pulse current <sup>2)</sup>              | $I_{S,pulse}$ |                                                                   | -   | -    | 120 |    |
| Diode forward voltage                          | $V_{SD}$      | $V_{GS}=0\text{ V}, I_F=30\text{ A},$<br>$T_j=25\text{ °C}$       | 0.6 | 0.95 | 1.3 | V  |
| Reverse recovery time <sup>2)</sup>            | $t_{rr}$      | $V_R=15\text{ V}, I_F=I_S,$<br>$di_F/dt=100\text{ A}/\mu\text{s}$ | -   | 12   | -   | ns |
| Reverse recovery charge <sup>2)</sup>          | $Q_{rr}$      |                                                                   | -   | 10   | -   | nC |

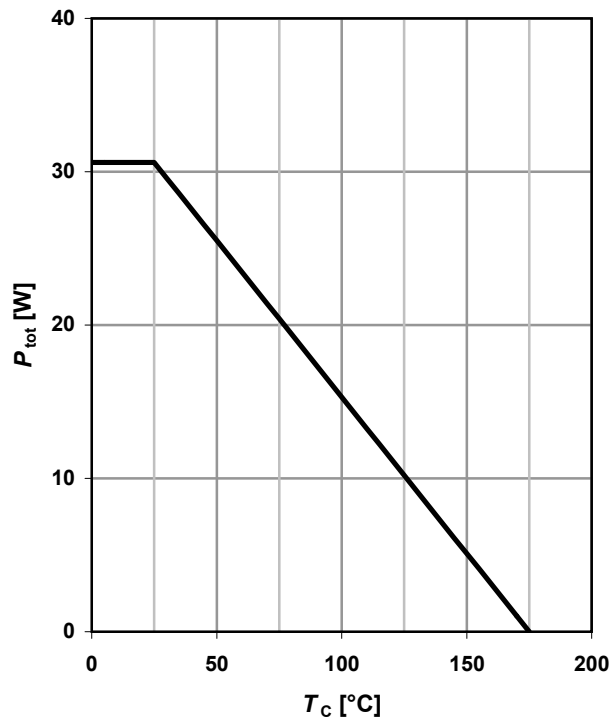
<sup>1)</sup> Current is limited by bondwire; with an  $R_{thJC} = 4.9\text{K/W}$  the chip is able to carry 38A at 25°C. For detailed information see Application Note ANPS071E at [www.infineon.com/optimos](http://www.infineon.com/optimos)

<sup>2)</sup> Defined by design. Not subject to production test.

<sup>3)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

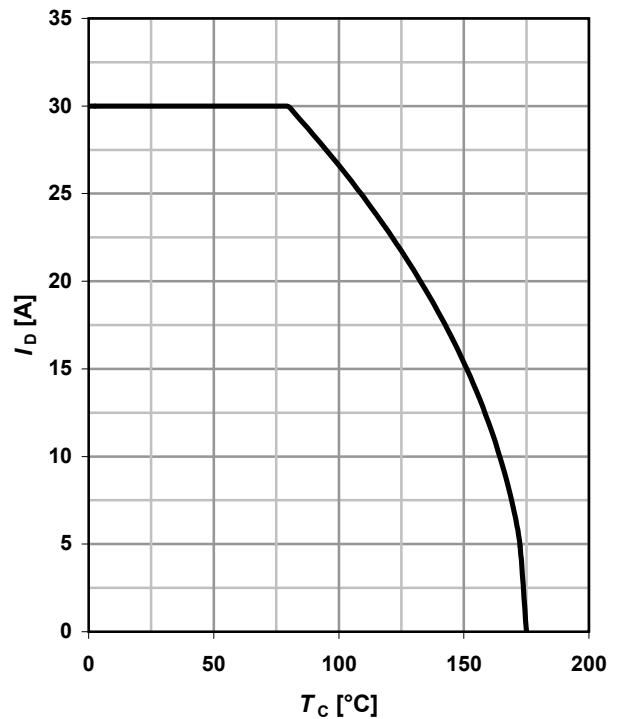
### 1 Power dissipation

$$P_{\text{tot}} = f(T_C); V_{\text{GS}} \geq 6 \text{ V}$$



### 2 Drain current

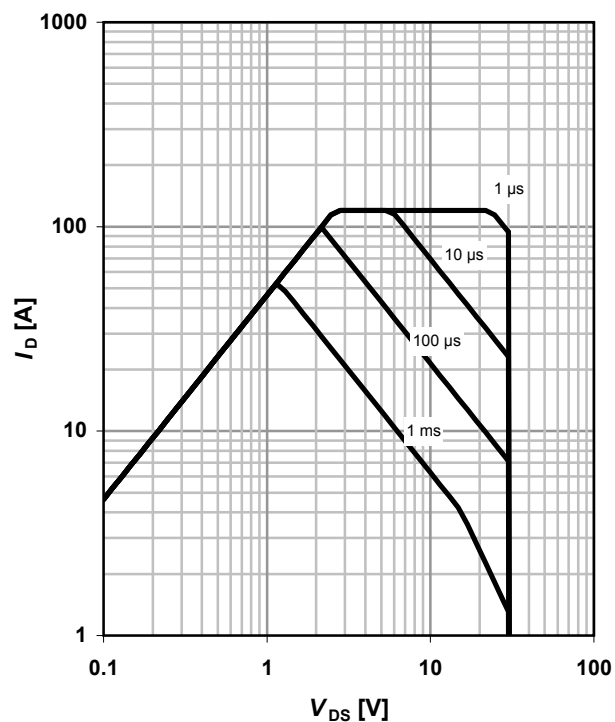
$$I_D = f(T_C); V_{\text{GS}} \geq 6 \text{ V}$$



### 3 Safe operating area

$$I_D = f(V_{\text{DS}}); T_C = 25 \text{ °C}; D = 0$$

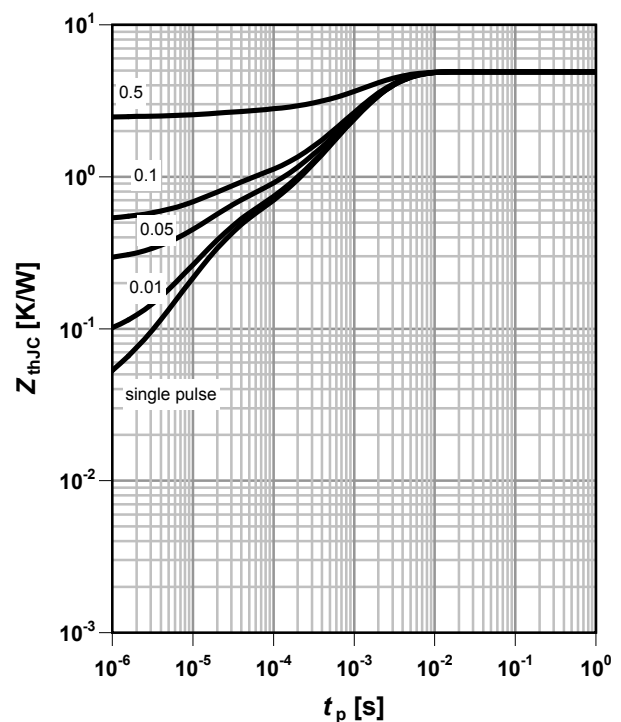
parameter:  $t_p$



### 4 Max. transient thermal impedance

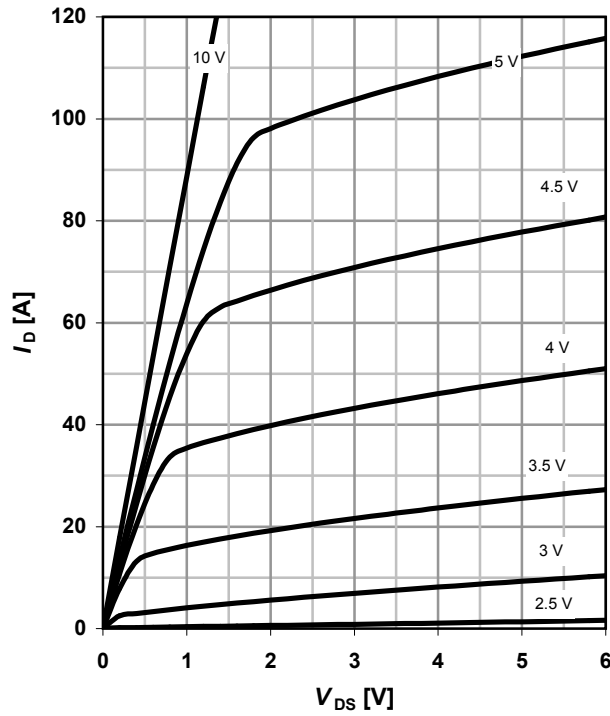
$$Z_{\text{thJC}} = f(t_p)$$

parameter:  $D = t_p/T$



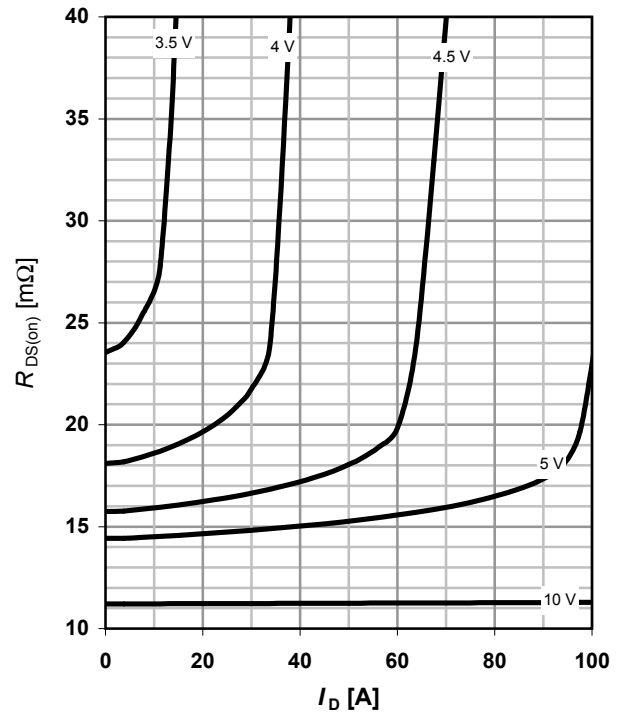
### 5 Typ. output characteristics

 $I_D = f(V_{DS}); T_j = 25^\circ\text{C}$ 

parameter:  $V_{GS}$ 


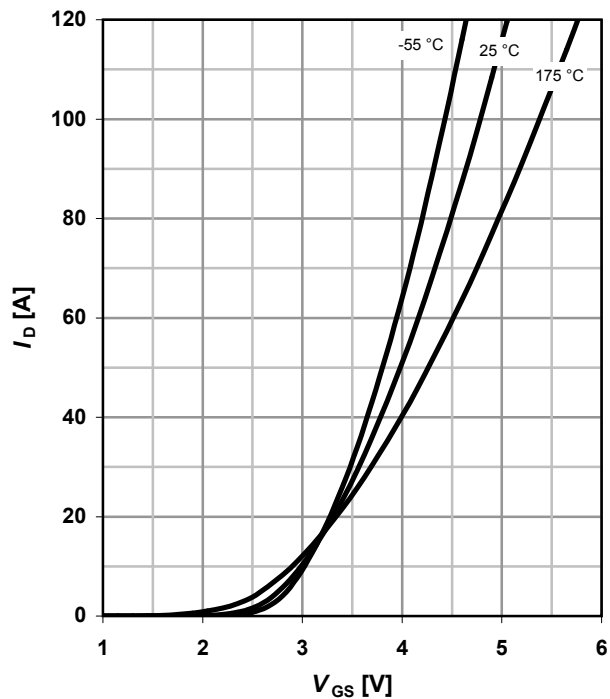
### 6 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(I_D); T_j = 25^\circ\text{C}$ 

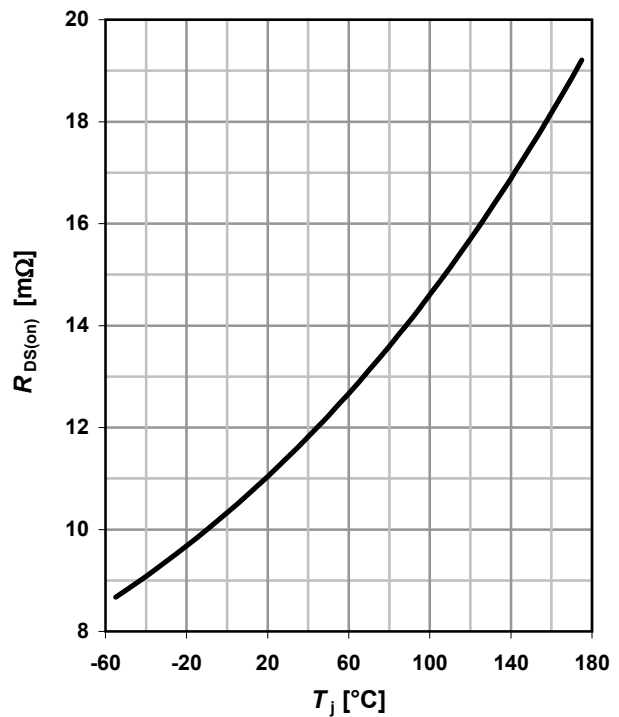
parameter:  $V_{GS}$ 


### 7 Typ. transfer characteristics

 $I_D = f(V_{GS}); V_{DS} = 6\text{V}$ 

parameter:  $T_j$ 


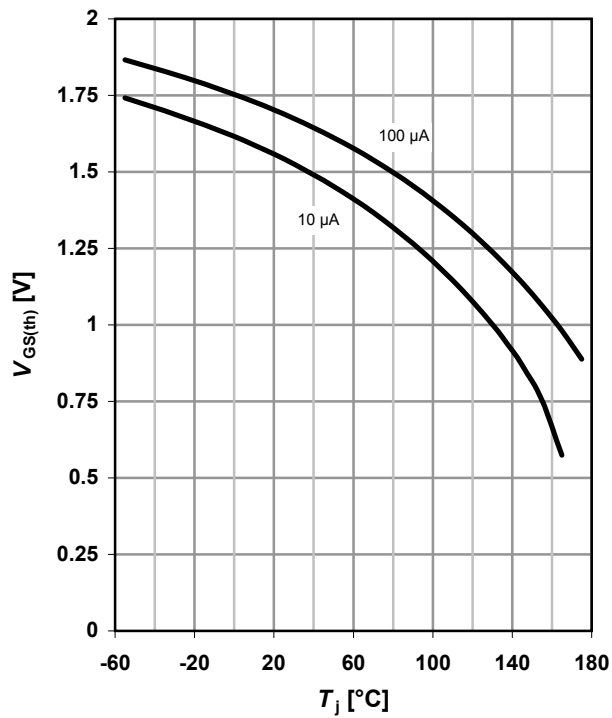
### 8 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(T_j); I_D = 30\text{ A}; V_{GS} = 10\text{ V}$ 


## 9 Typ. gate threshold voltage

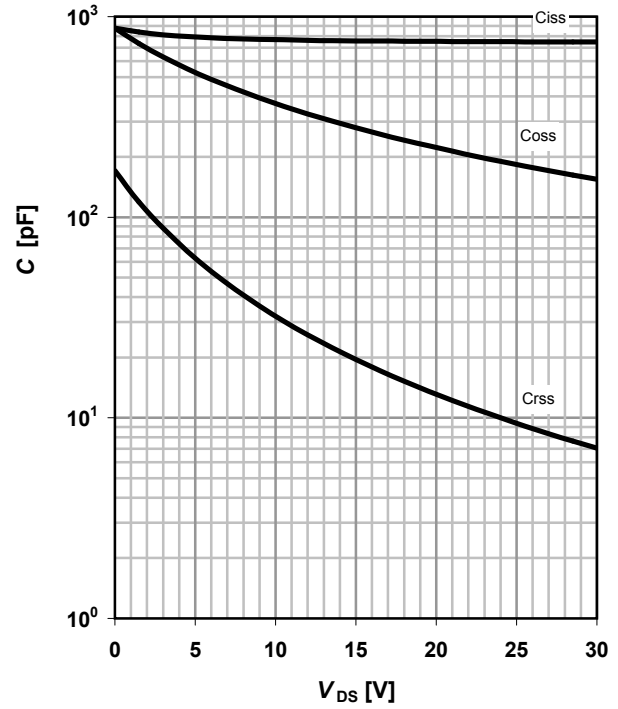
$$V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$$

parameter:  $I_D$



## 10 Typ. capacitances

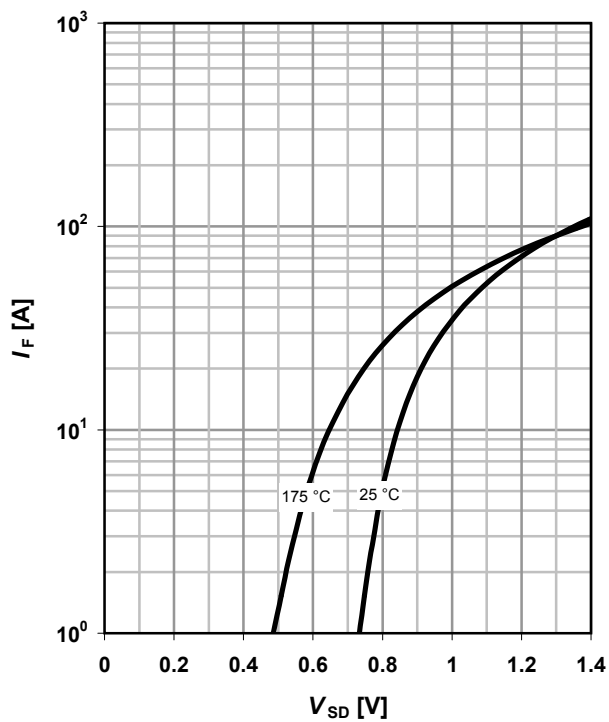
$$C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$$



## 11 Typical forward diode characteristics

$$I_F = f(V_{SD})$$

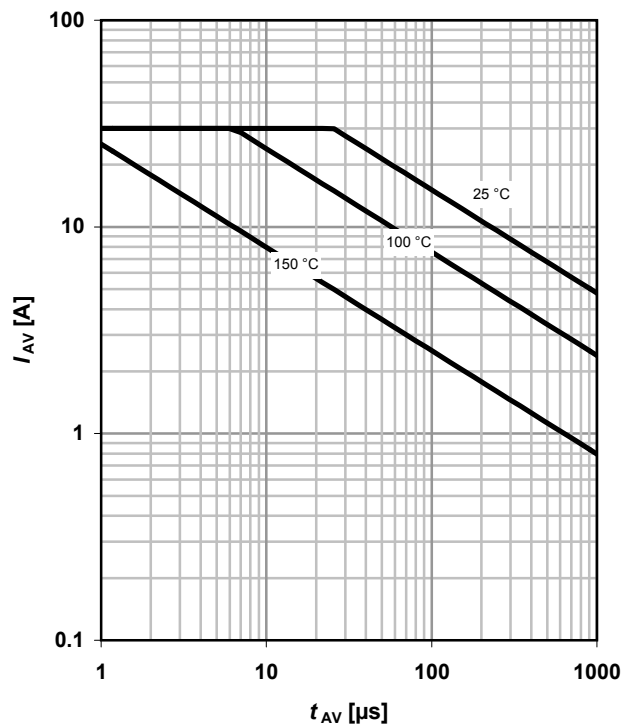
parameter:  $T_j$



## 12 Typ. avalanche characteristics

$$I_{AS} = f(t_{AV})$$

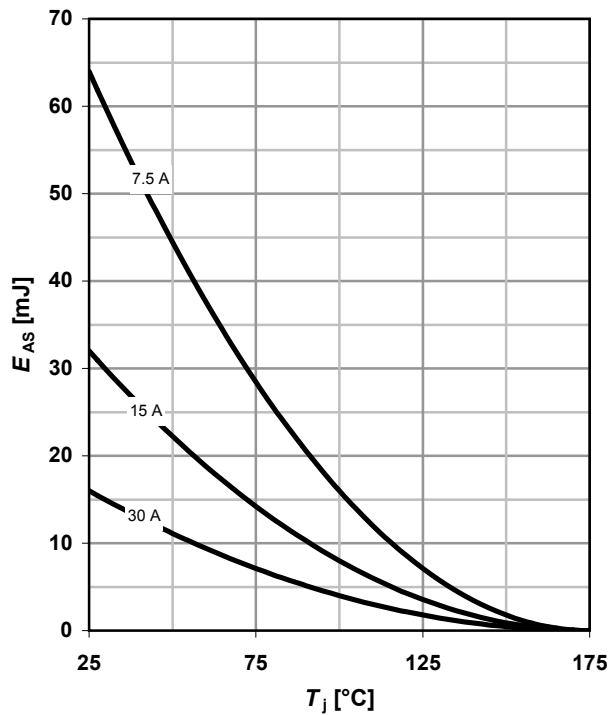
parameter:  $T_{j(start)}$



### 13 Typical avalanche energy

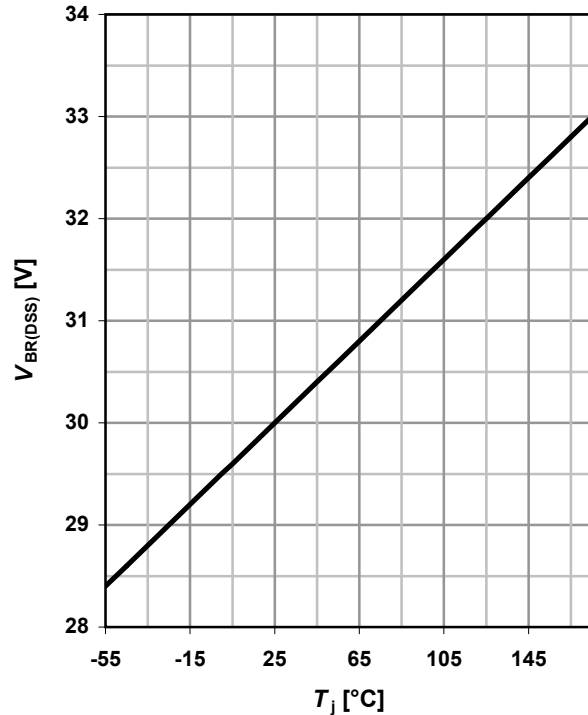
$$E_{AS} = f(T_j)$$

parameter:  $I_D$



### 14 Typ. drain-source breakdown voltage

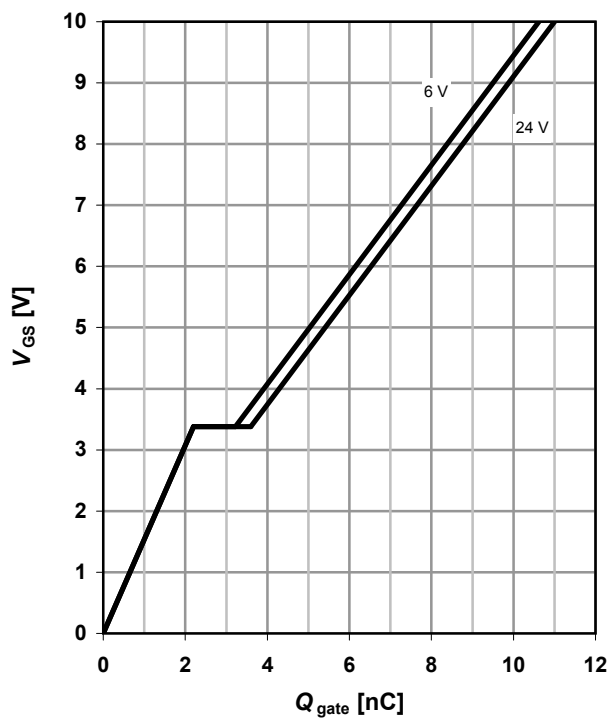
$$V_{BR(DSS)} = f(T_j); I_D = 1 \text{ mA}$$



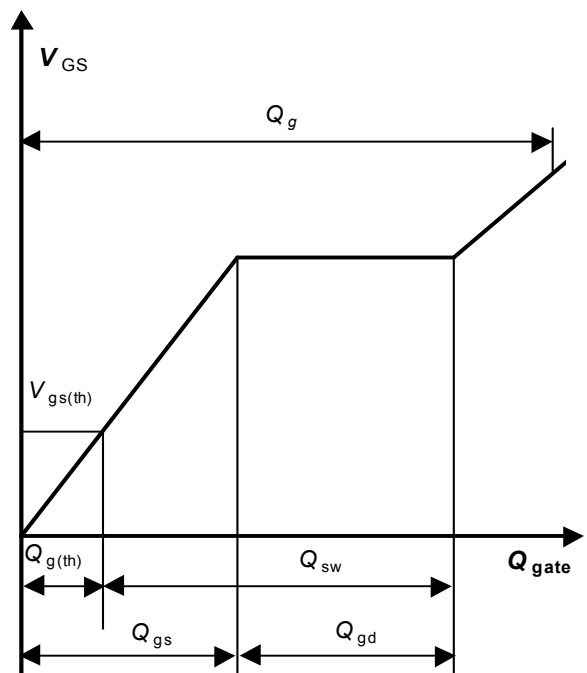
### 15 Typ. gate charge

$$V_{GS} = f(Q_{gate}); I_D = 30 \text{ A pulsed}$$

parameter:  $V_{DD}$



### 16 Gate charge waveforms



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Revision History

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| Version      | Date       | Changes                                         |
|--------------|------------|-------------------------------------------------|
| Revision 2.1 | 18.04.2008 | Update of type and marking in table on page one |

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